INTEGRATED CIRCUITS

DATA SHEET

74LV174

Hex D-type flip-flop with reset; positive-edge trigger

Product specification
Supersedes data of 1997 Apr 07
IC24 Data Handbook





Hex D-type flip-flop with reset; positive edge-trigger

74LV174

FEATURES

- Wide operating voltage: 1.0 to 5.5V
- Optimized for Low Voltage applications: 1.0 to 3.6V
- Accepts TTL input levels between V_{CC} = 2.7V and V_{CC} = 3.6V
- Typical V_{OLP} (output ground bounce) < 0.8V @ V_{CC} = 3.3V, $T_{amb} = 25^{\circ}C$
- Typical V_{OHV} (output V_{OH} undershoot) > 2V @ V_{CC} = 3.3V, $T_{amb} = 25^{\circ}C$
- Output capability: standard
- I_{CC} category: MSI

DESCRIPTION

The 74LV174 is a low-voltage Si-gate CMOS device and is pin and function compatible with the 74HC/HCT174.

The 74LV174 has six edge-triggered D-type flip-flops with individual D inputs and Q outputs. The common clock (CP) and master reset (MR) inputs load and reset (clear) all flip-flops simultaneously.

The register is fully edge-triggered. The state of each D input, one set-up time prior to the LOW-to-HIGH clock transition, is transferred to the corresponding output of the flip-flop.

A LOW level on the MR input forces all outputs LOW, independently of clock or data inputs.

The device is useful for applications requiring true outputs only and clock and master reset inputs that are common to all storage elements.

QUICK REFERENCE DATA

GND = 0V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5 \text{ ns}$

| SYMBOL | PARAMETER | CONDITIONS | TYPICAL | UNIT |
|------------------------------------|--|---|----------|------|
| t _{PHL} /t _{PLH} | Propagation delay CP to Q_n \overline{MR} to Q_n | C _L = 15pF V _{CC} = 3.3V | 16 13 | ns |
| f _{max} | Maximum clock frequency | | 77 | MHz |
| C _I | Input capacitance | | 3.5 | pF |
| C _{PD} | Power dissipation capacitance per flip-flop | V _{CC} = 3.3V Notes 1 and 2 | 17 | pF |

NOTES:

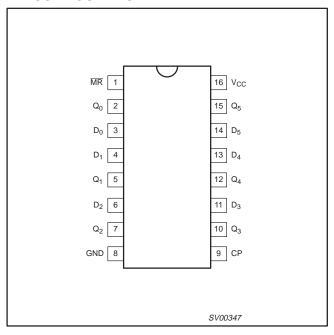
- 1. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W) $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; C_L = output load capacitance in pF; f_0 = output frequency in MHz; V_{CC} = supply voltage in V; Σ (C_L × V_{CC}² × f_o) = sum of the outputs. 2. The condition is V_I = GND to V_{CC}

ORDERING INFORMATION

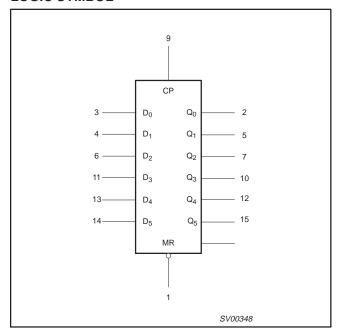
| PACKAGES | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | PKG. DWG. # |
|-----------------------------|-------------------|-----------------------|---------------|-------------|
| 16-Pin Plastic DIL | -40°C to +125°C | 74LV174 N | 74LV174 N | SOT38-4 |
| 16-Pin Plastic SO | -40°C to +125°C | 74LV174 D | 74LV174 D | SOT109-1 |
| 16-Pin Plastic SSOP Type II | -40°C to +125°C | 74LV174 DB | 74LV174 DB | SOT338-1 |
| 16-Pin Plastic TSSOP | -40°C to +125°C | 74LV174 PW | 74LV174PW DH | SOT403-1 |

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PIN CONFIGURATION



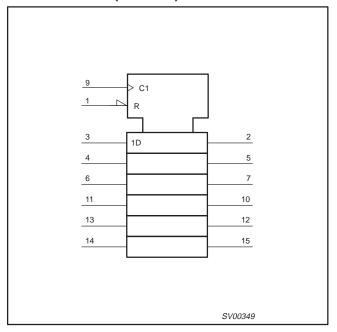
LOGIC SYMBOL



PIN DESCRIPTION

| PIN NUMBER | SYMBOL | FUNCTION | | | | |
|------------------------|----------------------------------|---|--|--|--|--|
| 1 | MR | Asynchronous master reset (active LOW) | | | | |
| 2, 5, 7, 10, 12, 15 | Q ₀ to Q ₅ | Flip-flop outputs | | | | |
| 3, 4, 6, 11, 13, 14 | D ₀ to D ₅ | Data inputs | | | | |
| 8 | GND | Ground (0V) | | | | |
| 9 CP | | Clock input (LOW-to-HIGH, edge-triggered) | | | | |
| 16 | V _{CC} | Positive supply voltage | | | | |

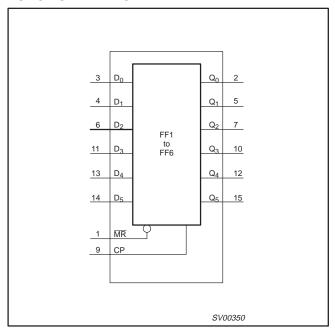
LOGIC SYMBOL (IEEE/IEC)



Hex D-type flip-flop with reset; positive edge-trigger

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FUNCTIONAL DIAGRAM



FUNCTION TABLE

| OPERATING MODES | | INPUTS | OUTPUTS | | |
|------------------|----|------------|----------------|-------|--|
| Of ERATING MODES | MR | СР | D _n | Q_0 | |
| Reset (clear) | L | Х | Х | L | |
| Load '1' | Н | 1 | h | Н | |
| Load '0' | Н | \uparrow | I | L | |

= HIGH voltage level

HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition

LOW voltage level

LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition

q Lower case letter indicates the state of referenced input one set-up time prior to the LOW-to-HIGH CP transition LOW-to-HIGH clock transition

RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP. | MAX | UNIT |
|---------------------------------|---|---|-------------|-------------|-------------------------|------|
| V _{CC} | DC supply voltage | See Note1 | 1.0 | 3.3 | 5.5 | V |
| VI | Input voltage | | 0 | - | V _{CC} | V |
| Vo | Output voltage | | 0 | - | V _{CC} | V |
| T _{amb} | Operating ambient temperature range in free air | See DC and AC characteristics | -40 -40 | | +85 +125 | °C |
| t _r , t _f | Input rise and fall times | $V_{CC} = 1.0V \text{ to } 2.0V$ $V_{CC} = 2.0V \text{ to } 2.7V$ $V_{CC} = 2.7V \text{ to } 3.6V$ $V_{CC} = 3.6V \text{ to } 5.5V$ | - - - | - - - | 500 200 100 50 | ns/V |

^{1.} The LV is guaranteed to function down to $V_{CC} = 1.0V$ (input levels GND or V_{CC}); DC characteristics are guaranteed from $V_{CC} = 1.2V$ to $V_{CC} = 5.5V$.

Hex D-type flip-flop with reset; positive edge-trigger

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ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134)

Voltages are referenced to GND (ground = 0V)

| SYMBOL | PARAMETER | CONDITIONS | RATING | UNIT |
|---|--|---|-------------------|------|
| V _{CC} | DC supply voltage | | -0.5 to +7.0 | V |
| ±I _{IK} | DC input diode current | $V_{I} < -0.5 \text{ or } V_{I} > V_{CC} + 0.5V$ | 20 | mA |
| ±I _{OK} | DC output diode current | $V_{O} < -0.5 \text{ or } V_{O} > V_{CC} + 0.5 V$ | 50 | mA |
| ±I _O | DC output source or sink current – standard outputs | $-0.5V < V_O < V_{CC} + 0.5V$ | 25 | mA |
| ±I _{GND} , ±I _{CC} | DC V _{CC} or GND current for types with –standard outputs | | 50 | mA |
| T _{stg} | Storage temperature range | | -65 to +150 | °C |
| P _{TOT} | Power dissipation per package -plastic DIL -plastic mini-pack (SO) -plastic shrink mini-pack (SSOP and TSSOP) | for temperature range: -40 to +125°C above +70°C derate linearly with 12mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K | 750 500 400 | mW |

NOTES:

DC CHARACTERISTICS FOR THE LV FAMILY

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

| | | | | | LIMITS | | | |
|-----------------|---|--|---------------------|------------------|---------------------|---------------------|---------------------|----------|
| SYMBOL | PARAMETER | TEST CONDITIONS | -40 |)°C to +8 | 5°C | -40°C to | +125°C | UNIT |
| | | | MIN | TYP ¹ | MAX | MIN | MAX | |
| | | V _{CC} = 1.2V | 0.9 | | | 0.9 | | |
| V _{IH} | HIGH level Input | V _{CC} = 2.0V | 1.4 | | | 1.4 | | |
| V IH | voltage | V _{CC} = 2.7 to 3.6V | 2.0 | | | 2.0 | |] |
| | | V _{CC} = 4.5 to 5.5V | 0.7*V _{CC} | | | 0.7*V _{CC} | | 1 |
| | | V _{CC} = 1.2V | | | 0.3 | | 0.3 | |
| V _{IL} | LOW level Input | V _{CC} = 2.0V | | | 0.6 | | 0.6 | |
| V IL | voltage | V _{CC} = 2.7 to 3.6V | | | 0.8 | | 0.8 | 1 ' |
| | | V _{CC} = 4.5 to 5.5 | | | 0.3*V _{CC} | | 0.3*V _{CC} | 1 |
| | | $V_{CC} = 1.2V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$ | | 1.2 | | | | |
| | HIGH level output voltage; all outputs | $V_{CC} = 2.0V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$ | 1.8 | 2.0 | | 1.8 | |] |
| | | $V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$ | 2.5 | 2.7 | | 2.5 | | V |
| ., | | $V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$ | 2.8 | 3.0 | | 2.8 | | 1 |
| V _{OH} | | $V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$ | 4.3 | 4.5 | | 4.3 | | |
| | HIGH level output voltage; | $V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 6\text{mA}$ | 2.40 | 2.82 | | 2.20 | | _ |
| | STANDARD outputs | $V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 12\text{mA}$ | 3.60 | 4.20 | | 3.50 | | <u> </u> |
| | | $V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$ | | 0 | | | | |
| | LOW level output | $V_{CC} = 2.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$ | | 0 | 0.2 | | 0.2 | |
| | voltage; all outputs | $V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$ | | 0 | 0.2 | | 0.2 | V |
| | | $V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$ | | 0 | 0.2 | | 0.2 | |
| V _{OL} | | $V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$ | | 0 | 0.2 | | 0.2 | |
| | LOW level output voltage; | $V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 6\text{mA}$ | | 0.25 | 0.40 | | 0.50 | _ |
| | STANDARD outputs | $V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 12\text{mA}$ | | 0.35 | 0.55 | | 0.65 | Ť |

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^{1.} Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC CHARACTERISTICS FOR THE LV FAMILY (Continued)

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

| SYMBOL | PARAMETER | TEST CONDITIONS | LIMITS | | | | | |
|------------------|---|--|----------------|--|------|----------|--------|------|
| STWIBOL | FARAMETER | TEST CONDITIONS | -40°C to +85°C | | | -40°C to | +125°C | UNIT |
| lı | Input leakage current | $V_{CC} = 5.5V$; $V_I = V_{CC}$ or GND | | | 1.0 | | 1.0 | μА |
| Icc | Quiescent supply current; MSI | $V_{CC} = 5.5V$; $V_{I} = V_{CC}$ or GND; $I_{O} = 0$ | | | 20.0 | | 160 | μА |
| Δl _{CC} | Additional quiescent supply current per input | $V_{CC} = 2.7V \text{ to } 3.6V; V_I = V_{CC} - 0.6V$ | | | 500 | | 850 | μА |

NOTE:

AC CHARACTERISTICS

GND = 0V; t_r = t_f = 2.5ns; C_L = 50pF; R_L = 1K Ω

| SYMBOL | PARAMETER | WAVEFORM | CONDITION | -4 | LIMITS 40 to +85 | С | LIM -40 to - | IITS ⊦125 °C | UNIT | |
|------------------------------------|---|-----------|---------------------|-----|---------------------|-----|-----------------|-----------------|------|--|
| | | | V _{CC} (V) | MIN | TYP ¹ | MAX | MIN | MAX | | |
| | | | 1.2 | _ | 100 | - | - | - | | |
| | | | 2.0 | - | 34 | 43 | - | 53 | | |
| t _{PHL} /t _{PLH} | Propagation delay CP to Q _n | Figure 1 | 2.7 | - | 25 | 31 | - | 39 | ns | |
| | Or to Q _n | | 3.0 to 3.6 | - | 19 ² | 25 | - | 31 | | |
| | | | 4.5 to 5.5 | - | 13 ³ | 21 | - | 26 | | |
| | | | 1.2 | _ | 80 | - | - | - | | |
| | l | | 2.0 | _ | 27 | 43 | - | 53 | | |
| t _{PHL} | Propagation delay MR to Q _n | Figure 2 | 2.7 | - | 20 | 31 | - | 39 | ns | |
| | I Will to Qn | | 3.0 to 3.6 | - | 15 ² | 25 | - | 31 | | |
| | | | 4.5 to 5.5 | - | 11 ³ | 21 | - | 26 | | |
| | | | | 2.0 | 34 | 10 | - | 41 | - | |
| | Clock pulse width | Figure 1 | 2.7 | 25 | 8 | - | 30 | - | ns | |
| t _W | HIGH to LOW | Figure 1 | 3.0 to 3.6 | 20 | 6 ² | - | 24 | - | 115 | |
| | | | 4.5 to 5.5 | 13 | 43 | | 16 | | 1 | |
| | | | 2.0 | 34 | 9 | - | 41 | - | | |
| | Master reset pulse | Figure 2 | 2.7 | 25 | 6 | - | 30 | - | no | |
| t _W | width LOW | Figure 2 | 3.0 to 3.6 | 20 | 5 | - | 24 | - | ns | |
| | | | 4.5 to 5.5 | 13 | 42 | | 16 | | | |
| | | | 1.2 | _ | -20 | - | - | - | | |
| | | | 2.0 | 5 | -7 | - | 5 | - | | |
| t _{rem} | Removal time MR to CP | Figure 2 | 2.7 | 5 | - 5 | - | 5 | - | ns | |
| | WINC TO OI | | 3.0 to 3.6 | 5 | -4 ² | - | 5 | - | | |
| | | | 4.5 to 5.5 | 5 | -3 ³ | | 5 | | | |
| | | | 1.2 | - | 10 | - | - | - | | |
| | | | 2.0 | 22 | 4 | - | 26 | - | | |
| t _{su} | Set-up time D _n to CP | Figure 3 | 2.7 | 16 | 3 | - | 19 | - | ns | |
| | 2,, 10 0, | I iguic o | 3.0 to 3.6 | 13 | 2 ² | - | 15 | - | 1 | |
| | | | 4.5 to 5.5 | 9 | 1 ³ | | 10 | | | |

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^{1.} All typical values are measured at T_{amb} = 25°C.

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AC CHARACTERISTICS (Continued)

GND = 0V; t_r = t_f = 2.5ns; C_L = 50pF; R_L = 1K Ω

| SYMBOL | PARAMETER | WAVEFORM | CONDITION | LIMITS -40 to +85 °C | | | LIMITS -40 to +125 °C | | UNIT | |
|------------------|---|----------|---------------------|-------------------------|------------------|-----------------|--------------------------|-----|---------|--|
| | | | V _{CC} (V) | MIN | TYP ¹ | MAX | MIN | MAX | | |
| | | | 1.2 | _ | -10 | _ | _ | _ | | |
| | | Figure 3 | 2.0 | 5 | -4 | _ | 5 | _ | | |
| t _h | t _h Hold time D _n to CP | | 2.7 | 5 | -2 | _ | 5 | _ | ns | |
| | _ ₁₁ to 0. | | | 3.0 to 3.6 | 5 | -2 ² | _ | 5 | _ | |
| | | | 4.5 to 5.5 | 5 | -1 ³ | | 5 | | | |
| | | | 2.0 | 14 | 40 | _ | 12 | _ | | |
| f | f Maximum clock | Figure 1 | 2.7 | 19 | 58 | _ | 16 | _ | MHz | |
| f _{max} | 'max pulse frequency | | 3.0 to 3.6 | 24 | 70 ² | - | 20 | - | IVII IZ | |
| | | | 4.5 to 5.5 | 36 | 100 ³ | | 30 | | | |

NOTES:

- 1. Unless otherwise stated, all typical values are at $T_{amb} = 25$ °C.
- 2. Typical value measured at $V_{CC} = 3.3V$.
- 3. Typical value measured at $V_{CC} = 5.0V$.

AC WAVEFORMS

 $V_{M} = 1.5V \text{ at } V_{CC} \ge 2.7V \le 3.6V$

 V_{M} = 0.5V * V_{CC} at V_{CC} < 2.7V and \geq 4.5V

 $\mbox{V}_{\mbox{OL}}$ and $\mbox{V}_{\mbox{OH}}$ are the typical output voltage drop that occur with the output load.

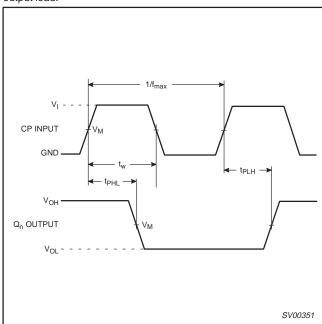


Figure 1. The clock (CP) to output $(\mathbf{Q_n})$ propagation delays, the clock pulse width, and the maximum clock pulse frequency.

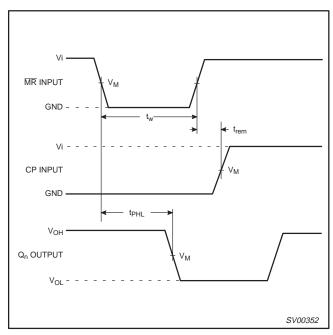


Figure 2. The master reset (\overline{MR}) pulse width, the master reset to output (Q_n) propagation delay and the master reset to clock removal time.

Hex D-type flip-flop with reset; positive edge-trigger

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AC WAVEFORMS (Continued)

 V_M = 1.5V at $V_{CC} \ge 2.7V \le 3.6V$ V_M = 0.5V * V_{CC} at $V_{CC} < 2.7V$ and $\ge 4.5V$

 $V_{\text{OL}}^{\text{}}$ and V_{OH} are the typical output voltage drop that occur with the output load.

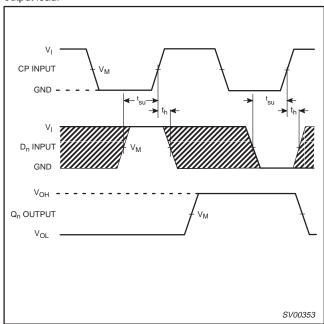


Figure 3. Data set-up and hold times for the data input $(D_{n)}$. NOTE:

The shaded areas indicate when the input is permitted to change for predictable output performance.

TEST CIRCUIT

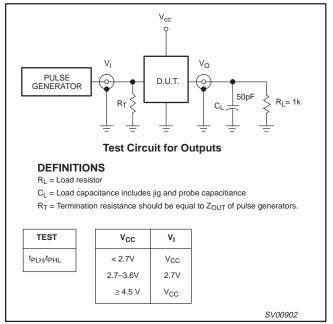
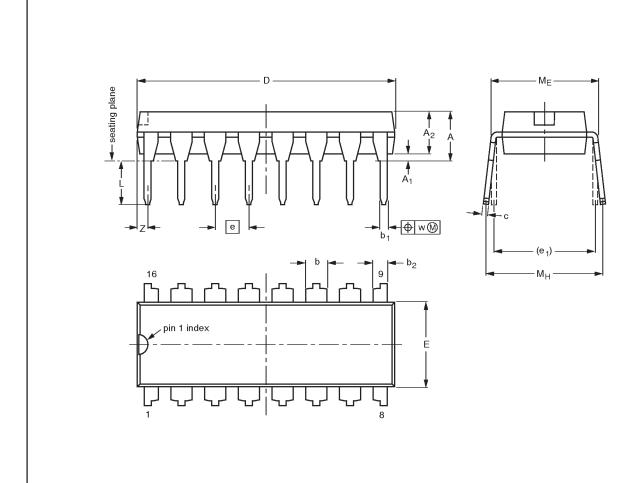


Figure 4. Load circuitry for switching times

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DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ min. | A ₂ max. | b | b ₁ | b ₂ | С | D ⁽¹⁾ | E (1) | е | e ₁ | L | ME | M _H | w | Z ⁽¹⁾ max. |
|--------|-----------|------------------------|------------------------|----------------|----------------|----------------|----------------|------------------|--------------|------|----------------|--------------|--------------|----------------|-------|--------------------------|
| mm | 4.2 | 0.51 | 3.2 | 1.73 1.30 | 0.53 0.38 | 1.25 0.85 | 0.36 0.23 | 19.50 18.55 | 6.48 6.20 | 2.54 | 7.62 | 3.60 3.05 | 8.25 7.80 | 10.0 8.3 | 0.254 | 0.76 |
| inches | 0.17 | 0.020 | 0.13 | 0.068 0.051 | 0.021 0.015 | 0.049 0.033 | 0.014 0.009 | 0.77 0.73 | 0.26 0.24 | 0.10 | 0.30 | 0.14 0.12 | 0.32 0.31 | 0.39 0.33 | 0.01 | 0.030 |

10 mm

Note

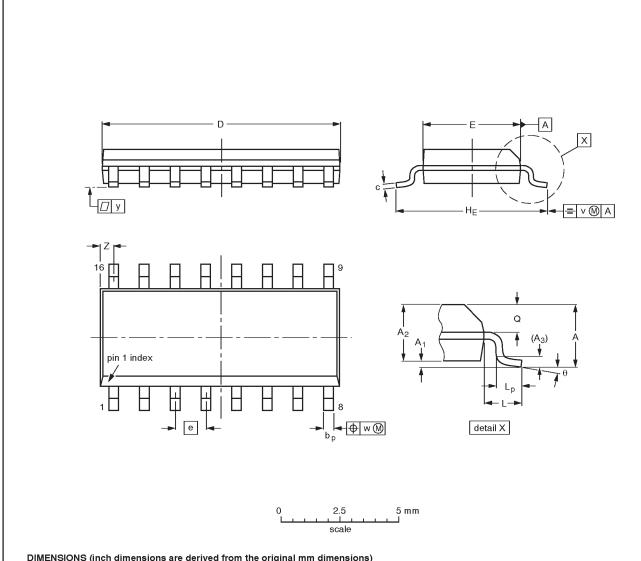
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | INE REFERENCES | EUROPEAN | ISSUE DATE | | | | |
|---------|----------------|----------|------------|--|------------|---------------------------------|--|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | ISSUE DATE | |
| SOT38-4 | | | | | | 92-11-17 95-01-14 | |

74LV174

plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | Α1 | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | ٦ | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|--------|-----------|------------------|----------------|-----------------------|--------------|------------------|------------------|------------------|-------|--------------|-------|----------------|----------------|------|------|-------|------------------|----|
| mm | 1.75 | 0.25 0.10 | 1.45 1.25 | 0.25 | 0.49 0.36 | 0.25 0.19 | 10.0 9.8 | 4.0 3.8 | 1.27 | 6.2 5.8 | 1.05 | 1.0 0.4 | 0.7 0.6 | 0.25 | 0.25 | 0.1 | 0.7 0.3 | 8° |
| inches | 0.069 | 0.0098 0.0039 | | 0.01 | l | 0.0098 0.0075 | 0.39 0.38 | 0.16 0.15 | 0.050 | 0.24 0.23 | 0.041 | 0.039 0.016 | 0.028 0.020 | 0.01 | 0.01 | 0.004 | 0.028 0.012 | 0° |

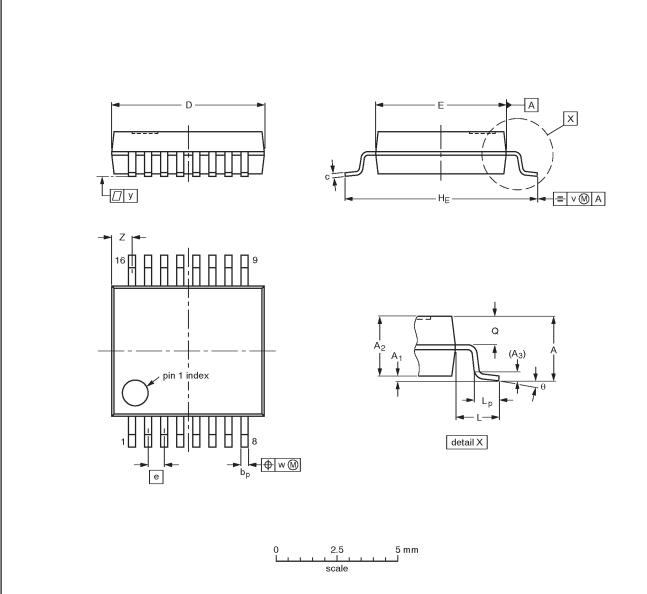
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | | | |
|----------|---------|----------|----------|------------|------------|---------------------------------|--|--|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | ISSUE DATE | | |
| SOT109-1 | 076E07S | MS-012AC | | | | 91-08-13 95-01-23 | | |

74LV174

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | рb | c | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|-----------------------|--------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| mm | 2.0 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 6.4 6.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 1.00 0.55 | 8° 0° |

Note

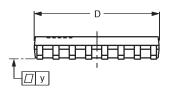
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

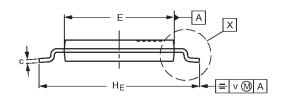
| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|----------|-----|----------|----------|------------|---------------------------------|--|
| VERSION | IEC | JEDEC | EIAJ | PROJECTION | ISSUE DATE | |
| SOT338-1 | | MO-150AC | | | 94-01-14 95-02-04 | |

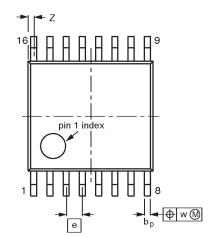
74LV174

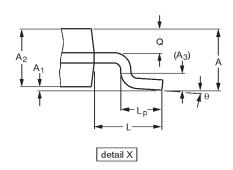
TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

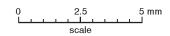
SOT403-1











DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | Α1 | A ₂ | A ₃ | рb | c | D ⁽¹⁾ | E ⁽²⁾ | Φ | HE | ٦ | Lp | Ø | ν | w | у | Z ⁽¹⁾ | θ |
|------|-----------|--------------|----------------|-----------------------|--------------|------------|------------------|------------------|------|------------|-----|--------------|------------|-----|------|-----|------------------|----------|
| mm | 1.10 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 5.1 4.9 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1.0 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.40 0.06 | 8° 0° |

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|----------|-----|--------|----------|------------|----------------------------------|--|
| VERSION | IEC | JEDEC | EIAJ | PROJECTION | ISSUE DATE | |
| SOT403-1 | | MO-153 | | | -94-07-12 95-04-04 | |

Hex D-type flip-flop with reset; positive edge-trigger

74LV174

NOTES

13

Hex D-type flip-flop with reset; positive edge-trigger

74LV174

| DEFINITIONS | | | | | | | | |
|--|------------------------|--|--|--|--|--|--|--|
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| Objective Specification | Formative or in Design | This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice. | | | | | | |
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